

Oscillator Specification: E3317LF(T) Issue 2, 24th July 2012

Outline: 614

Pad Function

1 Do not connect

2 Tri-state control

3 Ground

4 Output

5 Do not connect

6 Supply, Vs

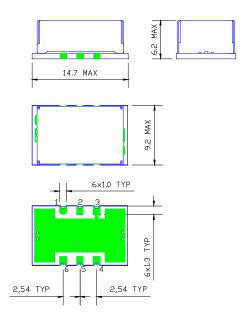
Marking shall include:

Model Number

Frequency

Date Code (Year/Week)

Antistatic symbol (Δ indicates pin 1)



Electrical:

Nominal Frequency, Fo 49.152 MHz Supply Voltage, Vs $3.3 \text{ V} \pm 10\%$ Input Current $\leq 8 \text{ mA}$

Output:

Type **CMOS** Load 15pF Vol ≤ 0.33V Voh ≥ 2.97V Rise/Fall time (10-90%) $\leq 8ns$ Symmetry (@ 1.65V level) 45 to 55%

Frequency Stability

Calibration @ 25 °C $\leq \pm 1.0$ ppm ref. to Fo Temperature, -40 to 85°C $\leq \pm 1.5$ ppm (ref. to Fmax+Fmin/2) $\leq \pm 0.2$ ppm ref. to frequency @ 3.3V Supply Voltage, ±10% Load changes, ±5pF $\leq \pm 0.1$ ppm ref. to frequency @ 15pF **Reflow Soldering** $\leq \pm 1.0$ ppm (allow 48 hours recovery)

Ageing, first year $\leq \pm 1.0 \text{ ppm}$ Ageing, 10 years $\leq \pm 3.0 \text{ ppm}$ None

Frequency Adjustment



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Tri-state

Output enabled Pad 2 open circuit or >0.6Vs

Pad 2 < 0.2Vs Output in tri-state mode

When in tri-state mode, the output stage is disabled but the oscillator and compensation circuit

are still active (current consumption <1.5mA).

Phase Noise @ 1 kHz offset

 \leq -115 dBc/Hz

Environmental:

IEC 60068-2-6 Test Fc, 10-60Hz, 1.5mm displacement, 60 –2000Hz at 98.1 ms⁻², 30 Vibration

minutes in each of three mutually perpendicular axes at 1 octave per minute.

IEC 60068-2-27 Test Ea, 980ms-2 acceleration for 6ms duration, 3 shocks in each direction Shock

along three mutually perpendicular axes.

SMD product suitable for Convection Reflow soldering. Peak temperature 230°C. Soldering

Maximum time above 200°C, 90 secs.

RoHS Part number with suffix 'LF' are fully compliant with the European Union directive

> 2002/95/EC on the restriction of the use of certain hazardous substances in electrical and electronic equipment. Note parts are suitable for assembly using both Lead-free solders and

Tin/Lead solders.

Packaging Parts in quantity ≥ 100 pcs are supplied on tape & reel (E3317LFT)

Solderability MIL-STD-202, Method 208, Category 3

Marking Laser Marked or Label